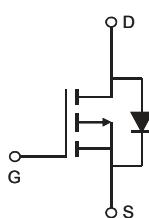
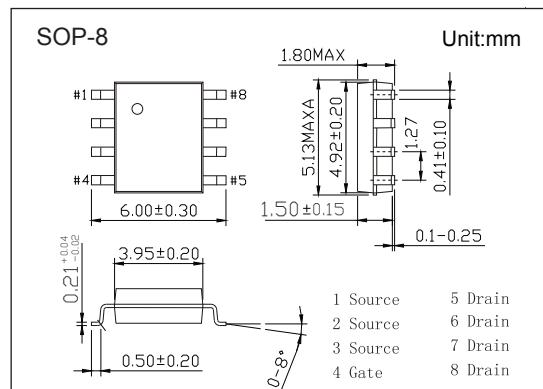


## P-channel MOSFET

## 2KJ7005

## ■ Features

- $V_{DS} = -30V$
- $I_D = -25 A$
- $R_{DS(on)} \leq 9m\Omega$  ( $V_{GS}=-10V$ )

■ Absolute Maximum Ratings ( $T_A = 25^\circ C$  unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current	$I_D$	-25	A
Pulsed Drain Current (Note 1)	$I_{DM}$	-70	
Maximum Power Dissipation	$P_D$	3.5	W
Thermal Resistance, Junction- to-Ambient	$R_{JA}^{\theta}$	36	$^\circ C/W$
Junction Temperature	$T_J$	150	$^\circ C$
Junction Storage Temperature Range	$T_{STG}$	-55 to 150	

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.

## P-channel MOSFET

## 2KJ7005

■ Electrical Characteristics ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	I <sub>D</sub> =-250μA, V <sub>Gs</sub> =0V	-30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>Ds</sub> =-30V, V <sub>Gs</sub> =0V			-1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>Ds</sub> =0V, V <sub>Gs</sub> =±20V			±100	nA
<b>On Characteristics (Note1)</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>Ds</sub> =V <sub>Gs</sub> , I <sub>D</sub> =-250μA	-1.0		-2.5	V
Static Drain-Source On-Resistance	R <sub>Ds(on)</sub>	V <sub>Gs</sub> =-10V, I <sub>D</sub> =-15A			9	mΩ
		V <sub>Gs</sub> =-4.5V, I <sub>D</sub> =-10A			14	
Forward Transconductance	g <sub>Fs</sub>	V <sub>Ds</sub> =-10V, I <sub>D</sub> =-15A	30			S
<b>Dynamic Characteristics (Note2)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>Gs</sub> =0V, V <sub>Ds</sub> =-15V, f=1MHz		3960		pF
Output Capacitance	C <sub>oss</sub>			486		
Reverse Transfer Capacitance	C <sub>rss</sub>			268		
<b>Switching Characteristics (Note2)</b>						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>Ds</sub> =-15V, I <sub>D</sub> =-10A, V <sub>Gs</sub> = -10 V, R <sub>GEN</sub> = 3 Ω		20		ns
Turn-On Rise Time	t <sub>r</sub>			13		
Turn-Off Delay Time	t <sub>d(off)</sub>			55		
Turn-Off Fall Time	t <sub>f</sub>			21		
Total Gate Charge	Q <sub>g</sub>	V <sub>Ds</sub> =-15V, I <sub>D</sub> =-10A, V <sub>Gs</sub> = -10V		65		nC
Gate Source Charge	Q <sub>gs</sub>			12		
Gate Drain Charge	Q <sub>gd</sub>			14		
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 1)	V <sub>SD</sub>	I <sub>SD</sub> =-25 A, V <sub>Gs</sub> =0V			-1.2	V

Notes:

1. Pulse Test: Pulse Width  $\leqslant 300 \mu\text{s}$ , Duty Cycle  $\leqslant 2\%$ .
2. Guaranteed by design, not subject to production

## ■ Marking

Marking	J7005 KC****
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## P-channel MOSFET

2KJ7005

## ■ Typical Electrical and Thermal Characteristics

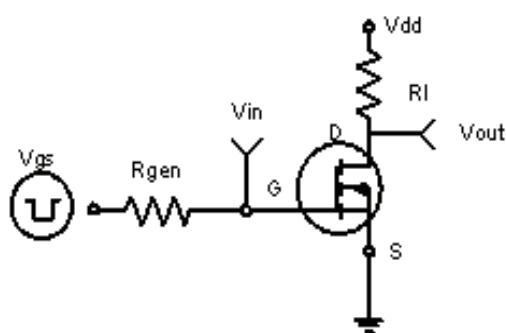


Figure 1 Switching Test Circuit

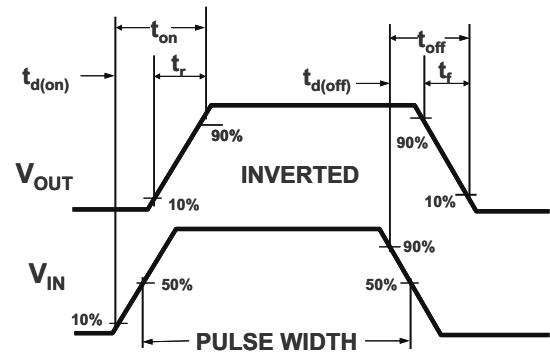


Figure 2 Switching Waveforms

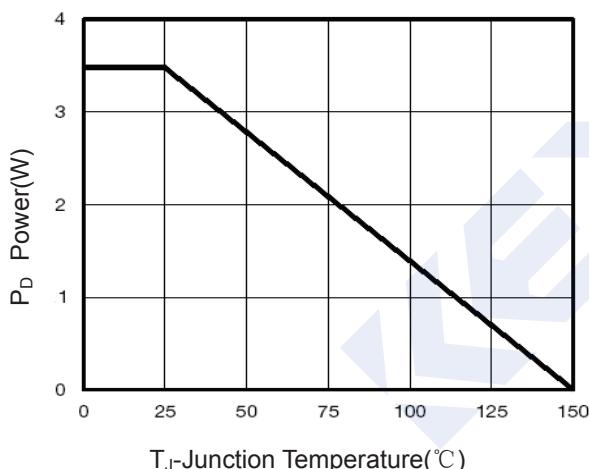


Figure 3 Power Dissipation

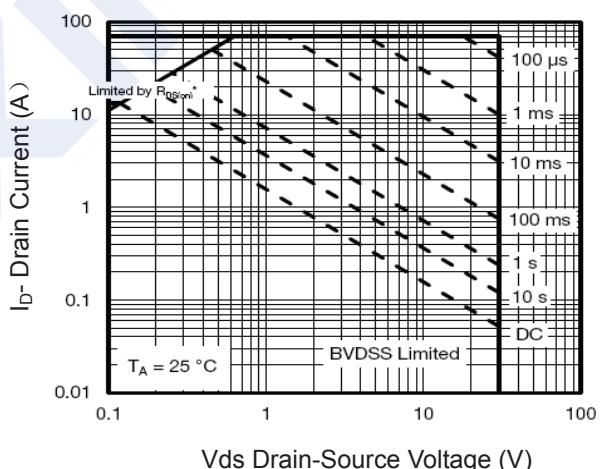


Figure 4 Safe Operation Area

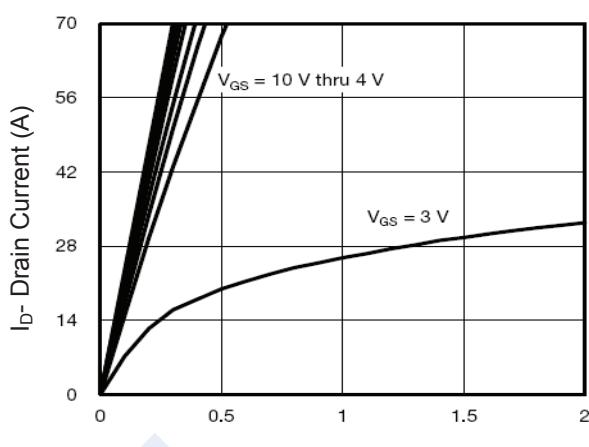


Figure 5 Output Characteristics

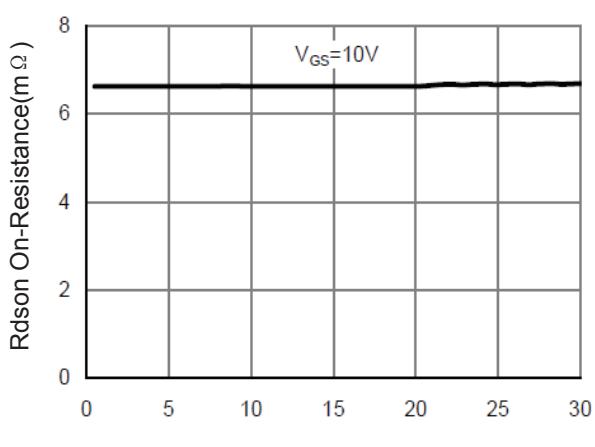


Figure 6 Drain-Source On-Resistance

## P-channel MOSFET

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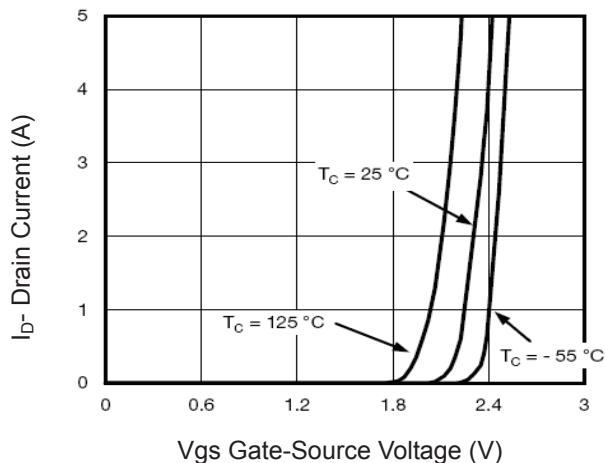


Figure 7 Transfer Characteristics  
 $I_D$ - Drain Current (A)  
 $V_{GS}$  Gate-Source Voltage (V)

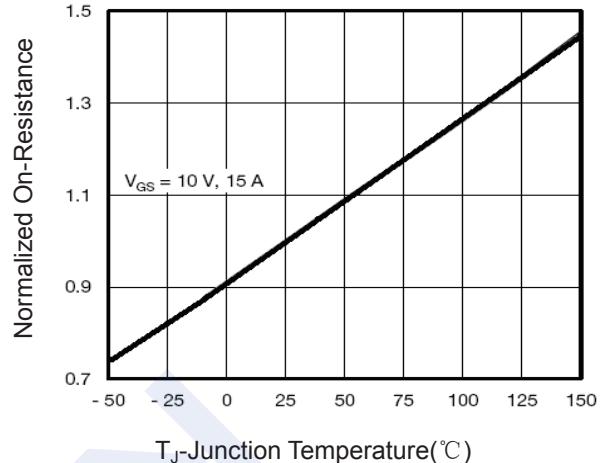


Figure 8 Drain-Source On-Resistance  
 $R_{DS(on)}$  Normalized On-Resistance  
 $T_J$ -Junction Temperature( $^\circ\text{C}$ )

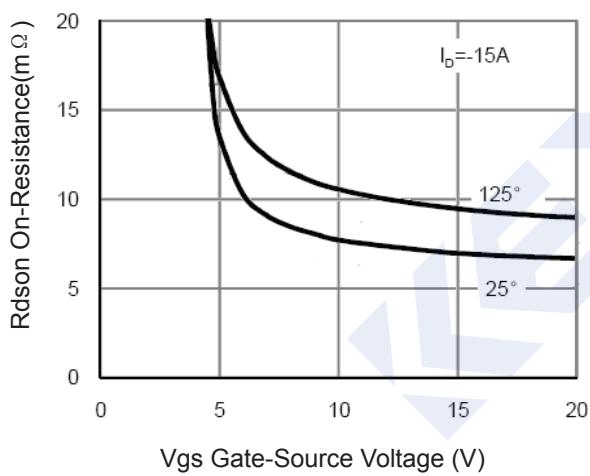


Figure 9  $R_{DS(on)}$  vs  $V_{GS}$   
 $R_{DS(on)}$  Drain-Source On-Resistance (mΩ)  
 $V_{GS}$  Gate-Source Voltage (V)

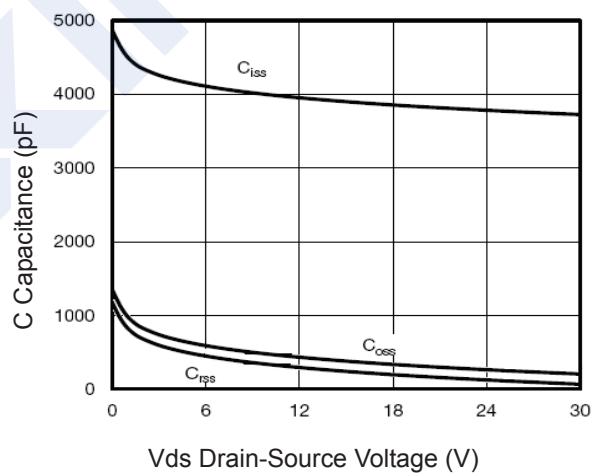


Figure 10 Capacitance vs  $V_{DS}$   
 $C$  Capacitance (pF)  
 $V_{DS}$  Drain-Source Voltage (V)

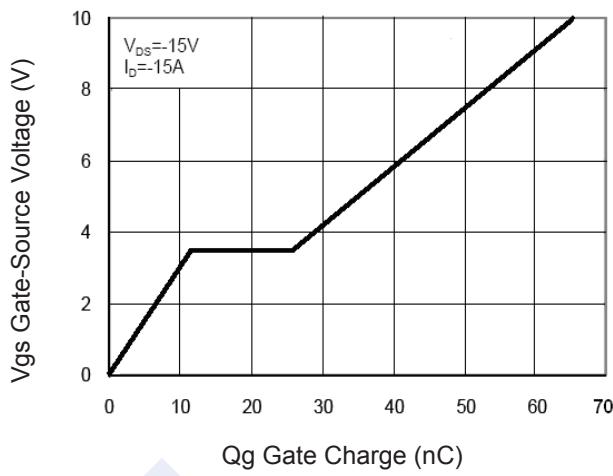


Figure 11 Gate Charge  
 $Q_g$  Gate Charge (nC)  
 $V_{GS}$  Gate-Source Voltage (V)

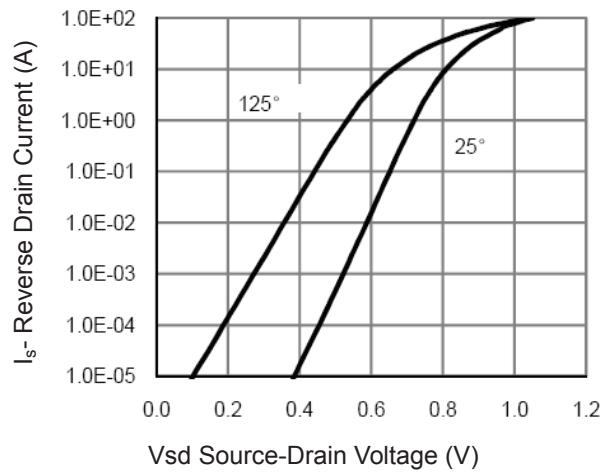
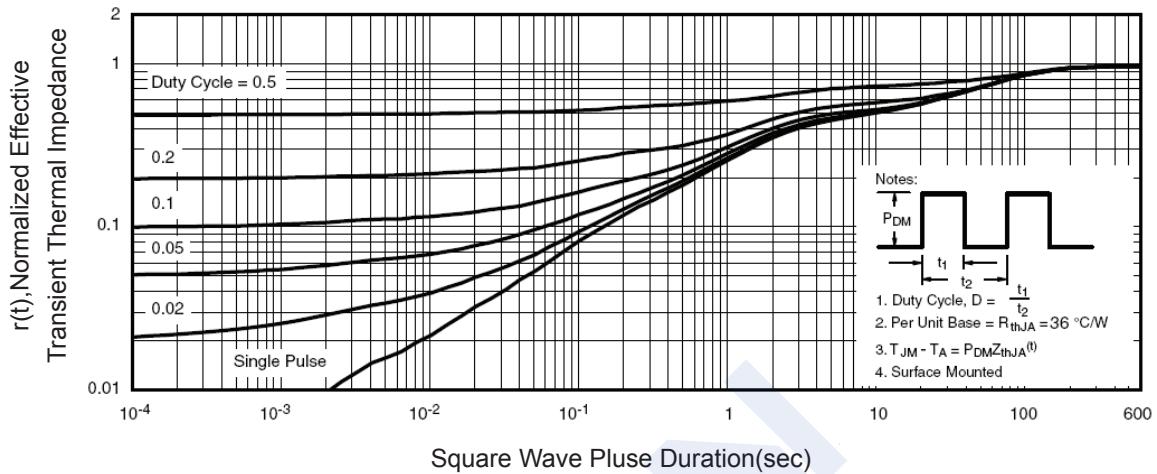


Figure 12 Source- Drain Diode Forward  
 $I_s$ - Reverse Drain Current (A)  
 $V_{SD}$  Source-Drain Voltage (V)

## P-channel MOSFET

**2KJ7005****Figure 13 Normalized Maximum Transient Thermal Impedance**